

**Surface Mount Superfast Recovery Rectifier**
**Reverse Voltage – 50 to 600 V**
**Forward Current – 1 A**
**FEATURES**

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

**MECHANICAL DATA**

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg / 0.00095oz

**ES1AF --- ES1JF**
**PINNING**

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View  
 Marking Code:  
 ES1AF~ES1JF: ES1A~ES1J  
 Simplified outline SMAF and symbol

**Absolute Maximum Ratings and Characteristics**

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.  
 For capacitive load, derate current by 20%.

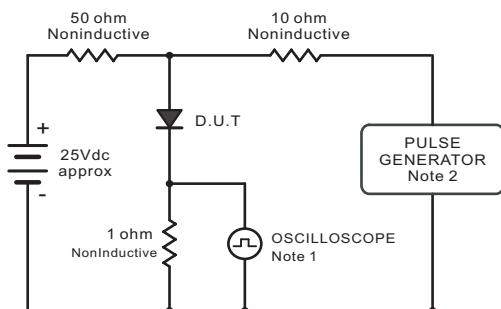
Parameter	Symbols	ES1AF	ES1BF	ES1CF	ES1DF	ES1EF	ES1GF	ES1JF	Units		
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	150	200	300	400	600	V		
Maximum RMS voltage	$V_{RMS}$	35	70	105	140	210	280	420	V		
Maximum DC Blocking Voltage	$V_{DC}$	50	100	150	200	300	400	600	V		
Maximum Average Forward Rectified Current at $T_L = 100^\circ\text{C}$	$I_{F(AV)}$	1						A			
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	30						A			
Maximum Forward Voltage at 1 A	$V_F$	1			1.25		1.65	V			
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Blocking Voltage $T_a = 125^\circ\text{C}$	$I_R$	5 100									
Typical Junction Capacitance at $V_R=4\text{V}$ , $f=1\text{MHz}$	$C_J$	10									
Maximum Reverse Recovery Time <sup>1)</sup>	$t_{rr}$	35									
Typical Thermal Resistance <sup>2)</sup>	$R_{\theta JA}$	115									
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150									

 1) Measured with  $I_F = 0.5 \text{ A}$ ,  $I_R = 1 \text{ A}$ ,  $I_{rr} = 0.25 \text{ A}$ 

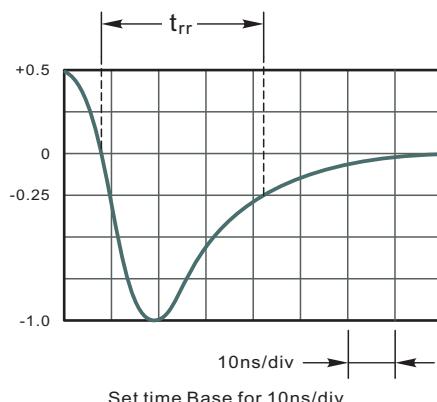
2) P.C.B. mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

### ES1AF ---ES1JF

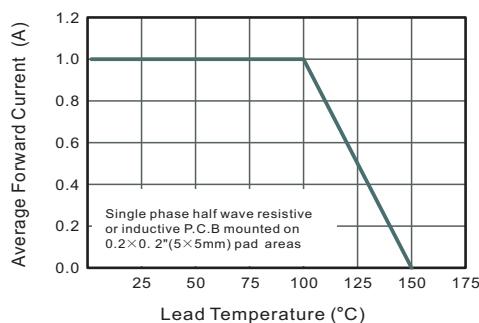
**Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram**



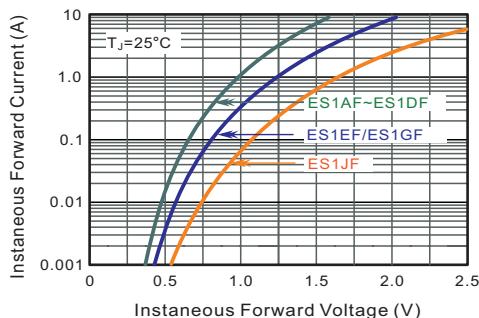
Note: 1. Rise Time = 7ns, max.  
 Input Impedance = 1megohm,22pF.  
 2. Ries Time =10ns, max.  
 Source Impedance = 50 ohms.



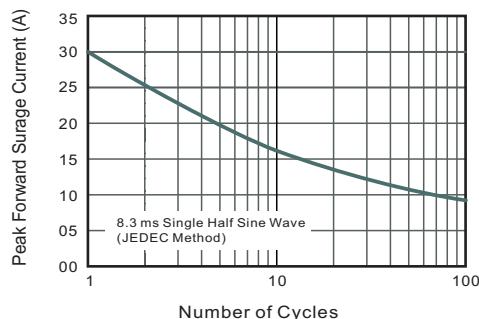
**Fig.2 Maximum Average Forward Current Rating**



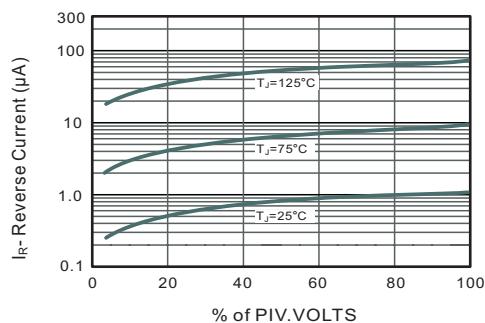
**Fig.4 Typical Forward Characteristics**



**Fig.6 Maximum Non-Repetitive Peak Forward Surge Current**



**Fig.3 Typical Reverse Characteristics**



**Fig.5 Typical Junction Capacitance**

